

# 74AHC08; 74AHCT08

## Quad 2-input AND gate

Rev. 03 — 14 November 2007

Product data sheet

## 1. General description

The 74AHC08; 74AHCT08 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard JESD7-A.

The 74AHC08; 74AHCT08 provides the quad 2-input AND function.

## 2. Features

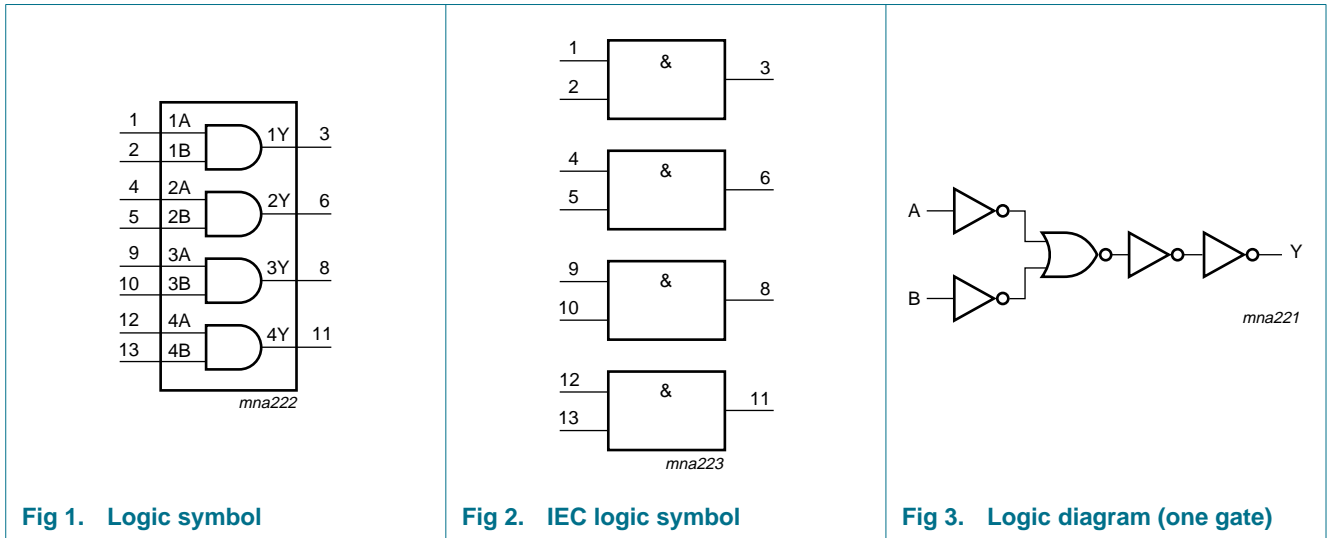
- Balanced propagation delays
- All inputs have a Schmitt-trigger action
- Inputs accepts voltages higher than  $V_{CC}$
- For 74AHC08 only: operates with CMOS input levels
- For 74AHCT08 only: operates with TTL input levels
- ESD protection:
  - ◆ HBM JESD22-A114E exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
  - ◆ CDM JESD22-C101C exceeds 1000 V
- Multiple package options
- Specified from  $-40\text{ °C}$  to  $+85\text{ °C}$  and from  $-40\text{ °C}$  to  $+125\text{ °C}$

## 3. Ordering information

Table 1. Ordering information

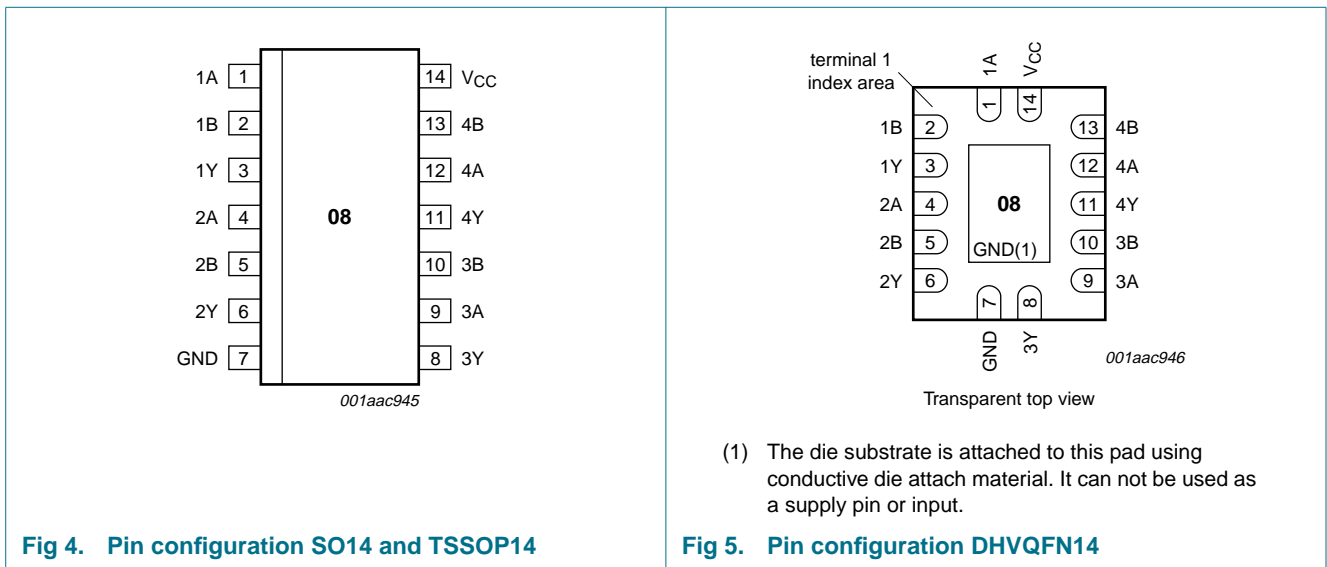
| Type number             | Package                             |          |  |          |
|-------------------------|-------------------------------------|----------|--|----------|
|                         | Temperature range                   | Name     | Description  | Version  |
| 74AHC08D<br>74AHCT08D   | $-40\text{ °C}$ to $+125\text{ °C}$ | SO14     | plastic small outline package; 14 leads;<br>body width 3.9 mm  | SOT108-1 |
| 74AHC08PW<br>74AHCT08PW | $-40\text{ °C}$ to $+125\text{ °C}$ | TSSOP14  | plastic thin shrink small outline package; 14 leads;<br>body width 4.4 mm  | SOT402-1 |
| 74AHC08BQ<br>74AHCT08BQ | $-40\text{ °C}$ to $+125\text{ °C}$ | DHVQFN14 | plastic dual in-line compatible thermal enhanced very<br>thin quad flat package; no leads; 14 terminals;<br>body $2.5 \times 3 \times 0.85$ mm | SOT762-1 |

### 4. Functional diagram



### 5. Pinning information

#### 5.1 Pinning



## 5.2 Pin description

**Table 2.** Pin description

| Symbol          | Pin | Description    |
|-----------------|-----|----------------|
| 1A              | 1   | data input     |
| 1B              | 2   | data input     |
| 1Y              | 3   | data output    |
| 2A              | 4   | data input     |
| 2B              | 5   | data input     |
| 2Y              | 6   | data output    |
| GND             | 7   | ground (0 V)   |
| 3Y              | 8   | data output    |
| 3A              | 9   | data input     |
| 3B              | 10  | data input     |
| 4Y              | 11  | data output    |
| 4A              | 12  | data input     |
| 4B              | 13  | data input     |
| V <sub>CC</sub> | 14  | supply voltage |

## 6. Functional description

**Table 3.** Function selection<sup>[1]</sup>

| Input |    | Output |
|-------|----|--------|
| nA    | nB | nY     |
| L     | X  | L      |
| X     | L  | L      |
| H     | H  | H      |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care

## 7. Limiting values

**Table 4.** Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions  | Min     | Max  | Unit |
|------------------|-------------------------|---|---------|------|------|
| V <sub>CC</sub>  | supply voltage          |   | -0.5    | +7.0 | V    |
| V <sub>I</sub>   | input voltage           |   | -0.5    | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < -0.5 V   | [1] -20 | -    | mA   |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> < -0.5 V or V <sub>O</sub> > V <sub>CC</sub> + 0.5 V | [1] -   | ±20  | mA   |
| I <sub>O</sub>   | output current          | V <sub>O</sub> = -0.5 V to (V <sub>CC</sub> + 0.5 V)                | -       | ±25  | mA   |
| I <sub>CC</sub>  | supply current          |   | -       | 75   | mA   |
| I <sub>GND</sub> | ground current          |   | -75     | -    | mA   |
| T <sub>stg</sub> | storage temperature     |   | -65     | +150 | °C   |

**Table 4. Limiting values ...continued**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions                           | Min   | Max | Unit |
|------------------|-------------------------|--------------------------------------|-------|-----|------|
| P <sub>tot</sub> | total power dissipation | T <sub>amb</sub> = -40 °C to +125 °C |       |     |      |
|                  | SO14 package            |                                      | [2] - | 500 | mW   |
|                  | TSSOP14 package         |                                      | [3] - | 500 | mW   |
|                  | DHVQFN14 package        |                                      | [4] - | 500 | mW   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] P<sub>tot</sub> derates linearly with 8 mW/K above 70 °C.

[3] P<sub>tot</sub> derates linearly with 5.5 mW/K above 60 °C.

[4] P<sub>tot</sub> derates linearly with 4.5 mW/K above 60 °C.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                           | Conditions                      | 74AHC08 |     |                 | 74AHCT08 |     |                 | Unit |
|------------------|-------------------------------------|---------------------------------|---------|-----|-----------------|----------|-----|-----------------|------|
|                  |                                     |                                 | Min     | Typ | Max             | Min      | Typ | Max             |      |
| V <sub>CC</sub>  | supply voltage                      |                                 | 2.0     | 5.0 | 5.5             | 4.5      | 5.0 | 5.5             | V    |
| V <sub>I</sub>   | input voltage                       |                                 | 0       | -   | 5.5             | 0        | -   | 5.5             | V    |
| V <sub>O</sub>   | output voltage                      |                                 | 0       | -   | V <sub>CC</sub> | 0        | -   | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature                 |                                 | -40     | +25 | +125            | -40      | +25 | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 3.3 V ± 0.3 V | -       | -   | 100             | -        | -   | -               | ns/V |
|                  |                                     | V <sub>CC</sub> = 5.0 V ± 0.5 V | -       | -   | 20              | -        | -   | 20              | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics**

Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions  | 25 °C |     |      | -40 °C to +85 °C |      | -40 °C to +125 °C |      | Unit |
|-----------------|---------------------------|---|-------|-----|------|------------------|------|-------------------|------|------|
|                 |                           |   | Min   | Typ | Max  | Min              | Max  | Min               | Max  |      |
| V <sub>IH</sub> | HIGH-level input voltage  | V <sub>CC</sub> = 2.0 V                             | 1.5   | -   | -    | 1.5              | -    | 1.5               | -    | V    |
|                 |                           | V <sub>CC</sub> = 3.0 V                             | 2.1   | -   | -    | 2.1              | -    | 2.1               | -    | V    |
|                 |                           | V <sub>CC</sub> = 5.5 V                             | 3.85  | -   | -    | 3.85             | -    | 3.85              | -    | V    |
| V <sub>IL</sub> | LOW-level input voltage   | V <sub>CC</sub> = 2.0 V                             | -     | -   | 0.5  | -                | 0.5  | -                 | 0.5  | V    |
|                 |                           | V <sub>CC</sub> = 3.0 V                             | -     | -   | 0.9  | -                | 0.9  | -                 | 0.9  | V    |
|                 |                           | V <sub>CC</sub> = 5.5 V                             | -     | -   | 1.65 | -                | 1.65 | -                 | 1.65 | V    |
| V <sub>OH</sub> | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> |       |     |      |                  |      |                   |      |      |
|                 |                           | I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 2.0 V    | 1.9   | 2.0 | -    | 1.9              | -    | 1.9               | -    | V    |
|                 |                           | I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 3.0 V    | 2.9   | 3.0 | -    | 2.9              | -    | 2.9               | -    | V    |
|                 |                           | I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 4.5 V    | 4.4   | 4.5 | -    | 4.4              | -    | 4.4               | -    | V    |
|                 |                           | I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V   | 2.58  | -   | -    | 2.48             | -    | 2.4               | -    | V    |
|                 |                           | I <sub>O</sub> = -8.0 mA; V <sub>CC</sub> = 4.5 V   | 3.94  | -   | -    | 3.8              | -    | 3.7               | -    | V    |

**Table 6. Static characteristics ...continued**  
 Voltages are referenced to GND (ground = 0 V).

| Symbol                   | Parameter                 | Conditions  | 25 °C |     |      | -40 °C to +85 °C |      | -40 °C to +125 °C |      | Unit |
|--------------------------|---------------------------|---|-------|-----|------|------------------|------|-------------------|------|------|
|                          |                           |   | Min   | Typ | Max  | Min              | Max  | Min               | Max  |      |
| V <sub>OL</sub>          | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>   |       |     |      |                  |      |                   |      |      |
|                          |                           | I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 2.0 V   | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                          |                           | I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 3.0 V   | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                          |                           | I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 4.5 V   | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                          |                           | I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V  | -     | -   | 0.36 | -                | 0.44 | -                 | 0.55 | V    |
|                          |                           | I <sub>O</sub> = 8.0 mA; V <sub>CC</sub> = 4.5 V  | -     | -   | 0.36 | -                | 0.44 | -                 | 0.55 | V    |
| I <sub>I</sub>           | input leakage current     | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V   | -     | -   | 0.1  | -                | 1.0  | -                 | 2.0  | μA   |
| I <sub>CC</sub>          | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 5.5 V  | -     | -   | 2.0  | -                | 20   | -                 | 40   | μA   |
| C <sub>I</sub>           | input capacitance         |   | -     | 3.0 | 10   | -                | 10   | -                 | 10   | pF   |
| <b>For type 74AHCT08</b> |                           |   |       |     |      |                  |      |                   |      |      |
| V <sub>IH</sub>          | HIGH-level input voltage  | V <sub>CC</sub> = 4.5 V to 5.5 V  | 2.0   | -   | -    | 2.0              | -    | 2.0               | -    | V    |
| V <sub>IL</sub>          | LOW-level input voltage   | V <sub>CC</sub> = 4.5 V to 5.5 V  | -     | -   | 0.8  | -                | 0.8  | -                 | 0.8  | V    |
| V <sub>OH</sub>          | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V   |       |     |      |                  |      |                   |      |      |
|                          |                           | I <sub>O</sub> = -50 μA   | 4.4   | 4.5 | -    | 4.4              | -    | 4.4               | -    | V    |
|                          |                           | I <sub>O</sub> = -8.0 mA  | 3.94  | -   | -    | 3.8              | -    | 3.7               | -    | V    |
| V <sub>OL</sub>          | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V   |       |     |      |                  |      |                   |      |      |
|                          |                           | I <sub>O</sub> = 50 μA  | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                          |                           | I <sub>O</sub> = 8.0 mA   | -     | -   | 0.36 | -                | 0.44 | -                 | 0.55 | V    |
| I <sub>I</sub>           | input leakage current     | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V   | -     | -   | 0.1  | -                | 1.0  | -                 | 2.0  | μA   |
| I <sub>CC</sub>          | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 5.5 V  | -     | -   | 2.0  | -                | 20   | -                 | 40   | μA   |
| ΔI <sub>CC</sub>         | additional supply current | per input pin; V <sub>I</sub> = V <sub>CC</sub> - 2.1 V; I <sub>O</sub> = 0 A; other pins at V <sub>CC</sub> or GND; V <sub>CC</sub> = 4.5 V to 5.5 V | -     | -   | 1.35 | -                | 1.5  | -                 | 1.5  | mA   |
| C <sub>I</sub>           | input capacitance         |   | -     | 3.0 | 10   | -                | 10   | -                 | 10   | pF   |

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**  
*GND = 0 V; For test circuit see Figure 7.*

| Symbol                   | Parameter                     | Conditions   | 25 °C            |                    |      | −40 °C to +85 °C |      | −40 °C to +125 °C |      | Unit |
|--------------------------|-------------------------------|--|------------------|--------------------|------|------------------|------|-------------------|------|------|
|                          |                               |  | Min              | Typ <sup>[1]</sup> | Max  | Min              | Max  | Min               | Max  |      |
| <b>For type 74AHC08</b>  |                               |  |                  |                    |      |                  |      |                   |      |      |
| t <sub>pd</sub>          | propagation delay             | nA, nB to nY; see Figure 6 <sup>[2]</sup><br>V <sub>CC</sub> = 3.0 V to 3.6 V              |                  |                    |      |                  |      |                   |      |      |
|                          |                               | C <sub>L</sub> = 15 pF   | -                | 4.0                | 8.8  | 1.0              | 10.5 | 1.0               | 11.0 | ns   |
|                          |                               | C <sub>L</sub> = 50 pF   | -                | 5.6                | 12.3 | 1.0              | 14   | 1.0               | 15.5 | ns   |
|                          |                               | V <sub>CC</sub> = 4.5 V to 5.5 V   |                  |                    |      |                  |      |                   |      |      |
|                          |                               | C <sub>L</sub> = 15 pF   | -                | 3.0                | 5.9  | 1.0              | 7.0  | 1.0               | 7.5  | ns   |
|                          |                               | C <sub>L</sub> = 50 pF   |                  | 4.2                | 7.9  | 1.0              | 9.0  | 1.0               | 10.0 | ns   |
| C <sub>PD</sub>          | power dissipation capacitance | C <sub>L</sub> = 50 pF; f <sub>i</sub> = 1 MHz;<br>V <sub>i</sub> = GND to V <sub>CC</sub> | <sup>[3]</sup> - | 10.0               | -    | -                | -    | -                 | -    | pF   |
| <b>For type 74AHCT08</b> |                               |  |                  |                    |      |                  |      |                   |      |      |
| t <sub>pd</sub>          | propagation delay             | nA, nB to nY; see Figure 6 <sup>[2]</sup><br>V <sub>CC</sub> = 4.5 V to 5.5 V              |                  |                    |      |                  |      |                   |      |      |
|                          |                               | C <sub>L</sub> = 15 pF   | -                | 3.2                | 6.9  | 1.0              | 8.0  | 1.0               | 9.0  | ns   |
|                          |                               | C <sub>L</sub> = 50 pF   | -                | 4.2                | 7.9  | 1.0              | 9.0  | 1.0               | 10.0 | ns   |
| C <sub>PD</sub>          | power dissipation capacitance | C <sub>L</sub> = 50 pF; f <sub>i</sub> = 1 MHz;<br>V <sub>i</sub> = GND to V <sub>CC</sub> | <sup>[3]</sup> - | 12.0               | -    | -                | -    | -                 | -    | pF   |

[1] Typical values are measured at nominal supply voltage (V<sub>CC</sub> = 3.3 V and V<sub>CC</sub> = 5.0 V).

[2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

[3] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f<sub>i</sub> = input frequency in MHz, f<sub>o</sub> = output frequency in MHz

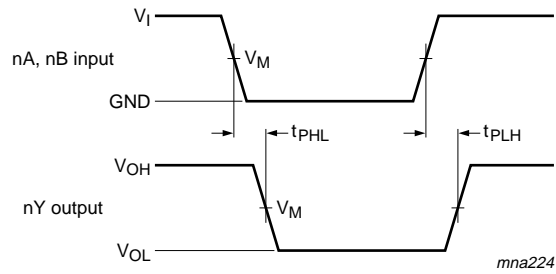
C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of the outputs.

## 11. Waveforms



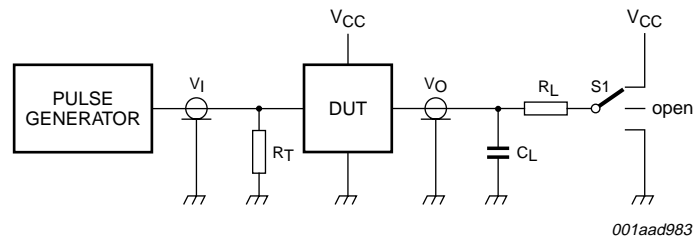
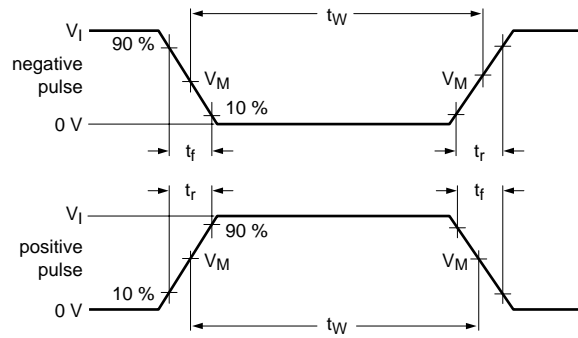
Measurement points are given in [Table 8](#).

$V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

**Fig 6. The input (nA, nB) to output (nY) propagation delays**

**Table 8. Measurement points**

| Type     | Input       | Output      |
|----------|-------------|-------------|
|          | $V_M$       | $V_M$       |
| 74AHC08  | $0.5V_{CC}$ | $0.5V_{CC}$ |
| 74AHCT08 | 1.5 V       | $0.5V_{CC}$ |



001aad983

Test data is given in [Table 9](#).

Definitions test circuit:

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_L$  = Load resistance.

S1 = Test selection switch.

**Fig 7. Load circuit for switching times**

**Table 9. Test data**

| Type     | Input    |               | Load         |              | S1 position        |                    |                    |
|----------|----------|---------------|--------------|--------------|--------------------|--------------------|--------------------|
|          | $V_I$    | $t_r, t_f$    | $C_L$        | $R_L$        | $t_{PHL}, t_{PLH}$ | $t_{PZH}, t_{PHZ}$ | $t_{PZL}, t_{PLZ}$ |
| 74AHC08  | $V_{CC}$ | $\leq 3.0$ ns | 15 pF, 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |
| 74AHCT08 | 3.0 V    | $\leq 3.0$ ns | 15 pF, 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |



12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

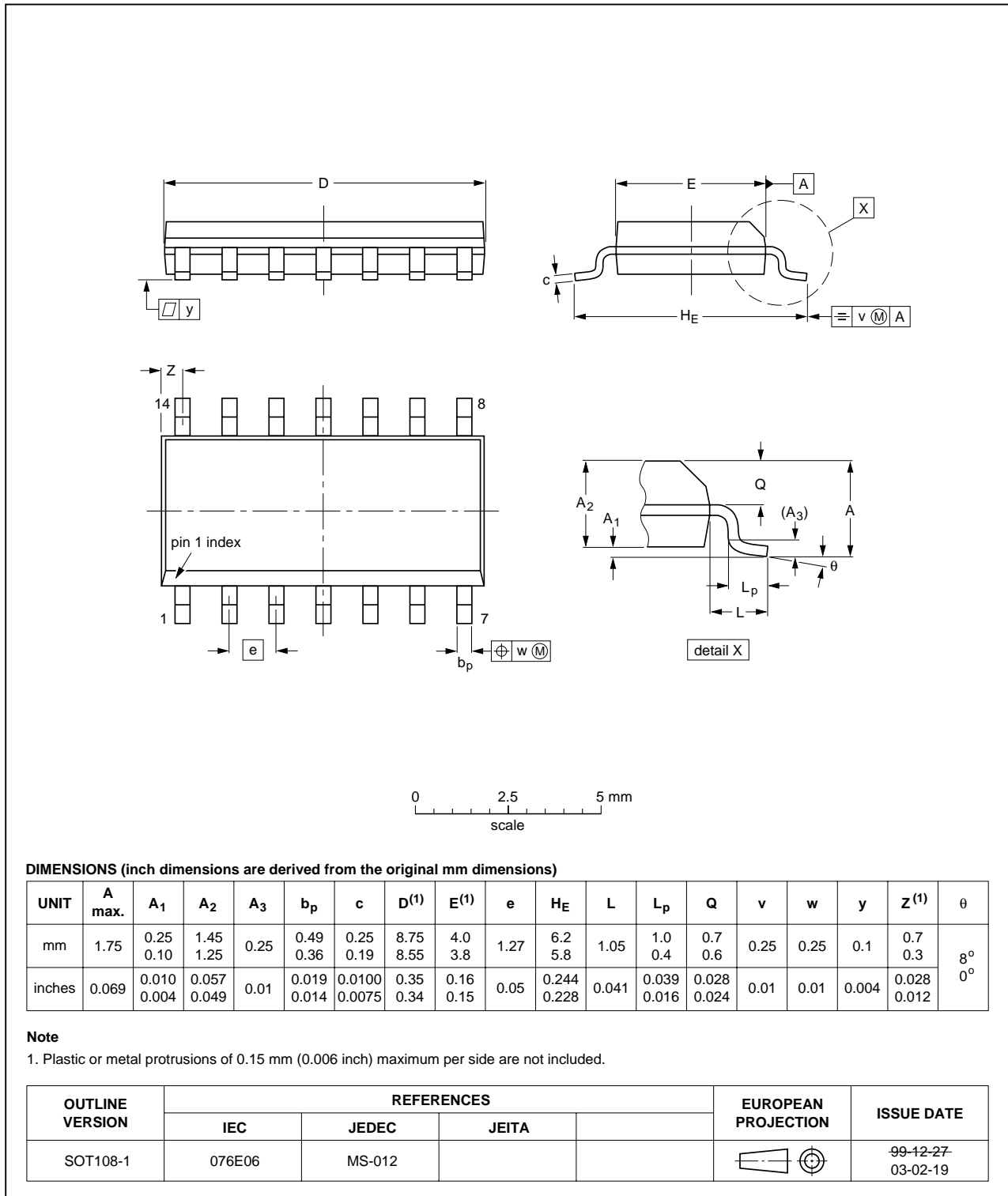


Fig 8. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

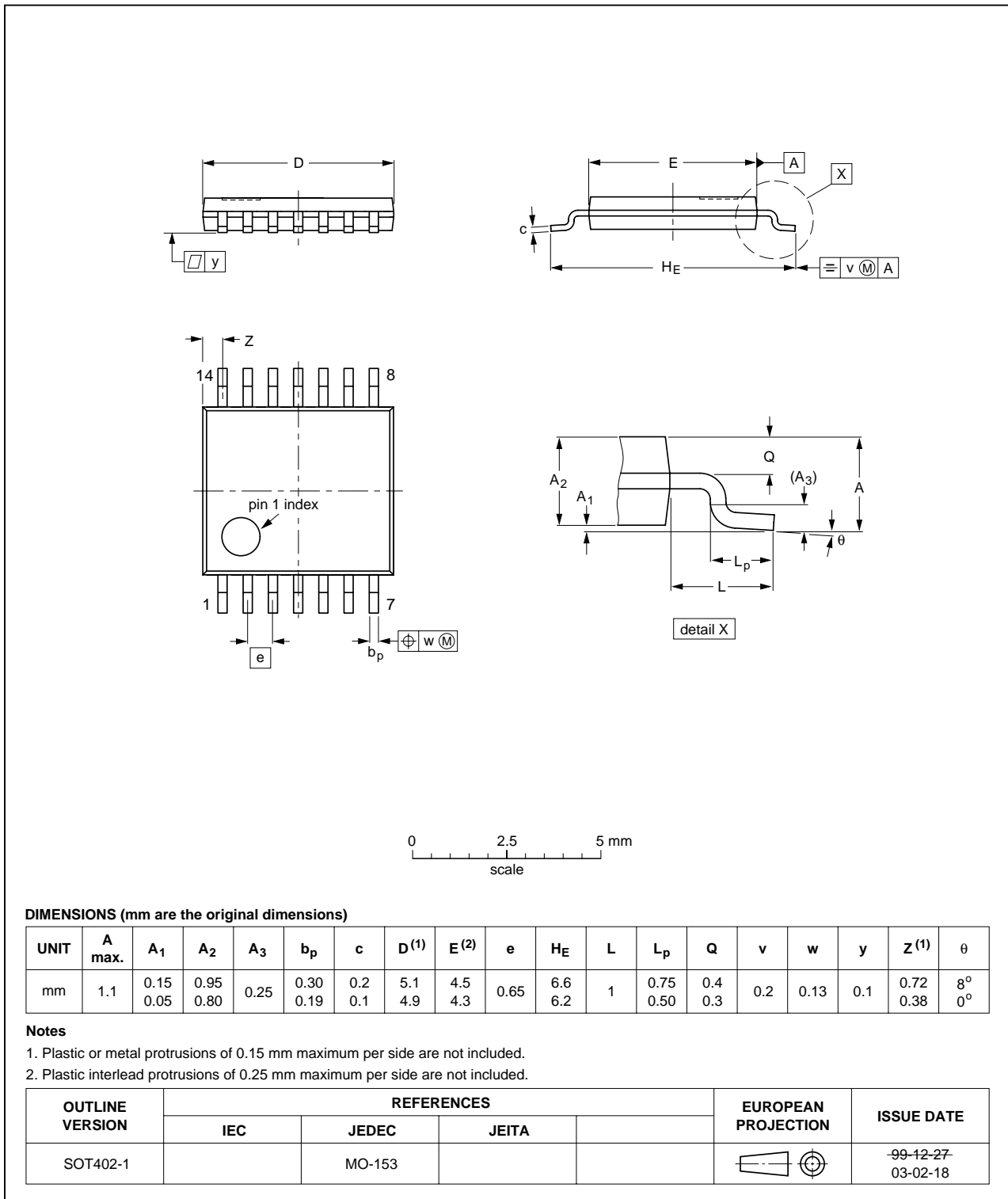


Fig 9. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

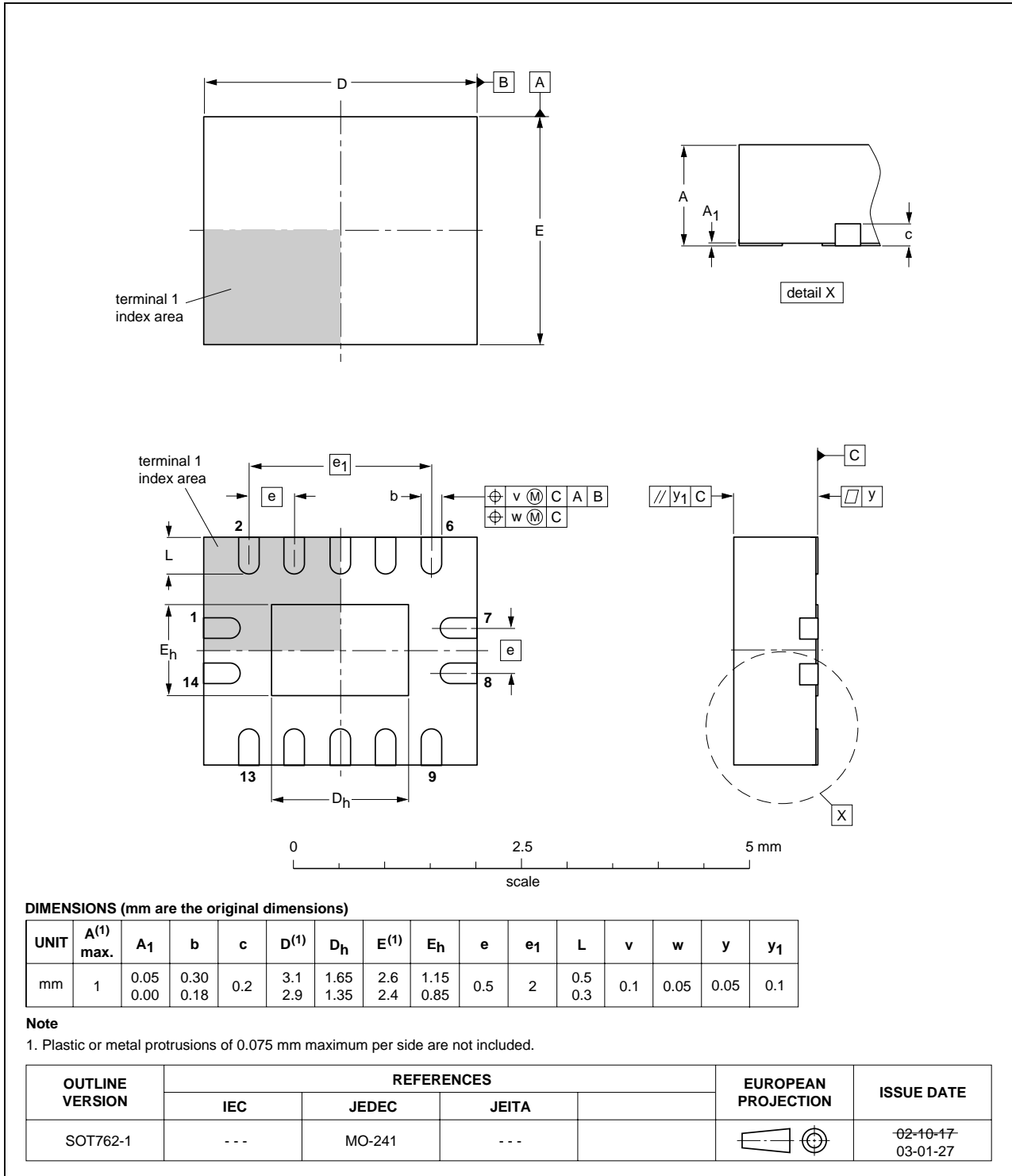


Fig 10. Package outline SOT762-1 (DHVQFN14)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                                    |
|---------|--|
| CMOS    | Complementary Metal Oxide Semiconductor        |
| LSTTL   | Low-power Schottky Transistor-Transistor Logic |
| ESD     | ElectroStatic Discharge                        |
| HBM     | Human Body Model                               |
| MM      | Machine Model                                  |
| CDM     | Charged Device Model                           |
| TTL     | Transistor-Transistor Logic                    |

## 14. Revision history

Table 11. Revision history

| Document ID    | Release date   | Data sheet status     | Change notice | Supersedes     |
|----------------|--|-----------------------|---------------|----------------|
| 74AHC_AHCT08_3 | 20071114   | Product data sheet    | -             | 74AHC_AHCT08_2 |
| Modifications: | <ul style="list-style-type: none"> <li>• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>• Legal texts have been adapted to the new company name where appropriate.</li> <li>• <a href="#">Section 3</a>: DHVQFN14 package added.</li> <li>• <a href="#">Section 7</a>: derating values added for DHVQFN14 package.</li> <li>• <a href="#">Section 12</a>: outline drawing added for DHVQFN14 package.</li> </ul> |                       |               |                |
| 74AHC_AHCT08_2 | 19990924   | Product specification | -             | 74AHC_AHCT08_1 |
| 74AHC_AHCT08_1 | 19981218   | Product specification | -             | -              |

## 15. Legal information

### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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